

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20200715000 Datasheet for LMV321, LMV324, LMV358 Information Only

Date: July 21, 2020

To: PREMIER FARNELL PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (<u>PCN www admin team@list.ti.com</u>).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
LMV321IDBVR	null
LMV324IDR	null
LMV324IPWR	null
LMV358ID	null
LMV358IDGKR	null
LMV358IDR	null

Technical details of this Product Change follow on the next page(s).

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Notification Number: 20200715000 Notification Date: July 21, 2020							
	Title: Datasheet for LMV321, LMV324, LMV358						
	r Contact: PCN Manag	<u>er</u>		Dept:		Quality Services	
Change 1	ype:						
Asser	nbly Site		Design		Wafer	Bump Site	
Asser	nbly Process	\boxtimes	Data Sheet		Wafer	Bump Material	
Asser	nbly Materials		Part number change		Wafer	Bump Process	
	anical Specification		Test Site		Wafer	Fab Site	
Packi	ng/Shipping/Labeling		Test Process		Wafer	Fab Materials	
					Wafer	Fab Process	
	Notification Details						
Descripti	on of Change:						
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.							
TEX	AS TRUMENTS				LMV	321, LMV324, LMV358	
1143	STRUMENTS			SLOS		UST 1999-REVISED MAY 2020	
Changes	from Revision W (October 2014)	to Re	evision X			Page	
 Delete 	d LMV324S mentions on the front	page	of the data sheet			1	
 Added 	end equipment links in Application	secti	on			1	
 Added 	recommended device notice for LI	MV32	1A, LMV358A, and LMV324A			1	
 Change 	ed Device Information table to sort	devid	es by channel count in ascending of	order		1	
 Chang 	ed Pin Configuration and Function	s sect	ion by dividing the Pin Functions ta	ble into	separate	tables per device 3	
 Delete 	d LMV324S pinout information					4	
 Change 	Deleted LMV324S pinout information						
_							
	5 11 101 11 11 11 11 11 11 11 11 11 11 11						
	Changed Thermal Information section by dividing the Thermal Information table into separate tables per device						
_							
	Deleted LMV324S Thermal Information						
 Change 	Changed Thermal Information for LMV358						
-	Deleted LMV324S test condition for supply current						
	Changed output short-circuit current for sourcing from 60 mA to 40 mA						
	Changed output short-circuit current for sinking from 160 mA to 40 mA						
	Deleted LMV324S test condition for supply current						
Added assured by characterization table notes to output short-circuit current, output swing, and input bias current specifications							
Changed Source Current Vs Output Voltage V _{CC} =2.7V plot with Output Voltage vs Output Current (Claw) plot in Typical Characteristics section							
	 Deleted plots Source Current Vs Output Voltage V_{cc}= 5V, Sinking Current vs Output Voltage V_{cc}=2.7V, Sinking Current vs Output Voltage V_{cc}=5V, Short-Circuit Current vs Temperature in <i>Typical Characteristics</i> section						
	Changed Open-Loop Output Impedance Vs Frequency plot in Typical Characteristics section						
	Added Receiving Notification and Support Resources sections to the Device and Documentation Support section 23						
The datasheet number will be changing. Device Family Change From: Change To:							
Device I							
LMV321,	MV321, LMV324, LMV358 SLOS263W SLOS263X					63X	

These changes may be reviewed at the datasheet links provided.

http://www.ti.com/product/LMV321

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this notification:

None.

Product Affected:

LMV321IDBVR	LMV321IDBVRE4	LMV321IDBVRG4	LMV321IDBVT
LMV321IDBVTE4	LMV321IDCKR	LMV321IDCKRG4	LMV321IDCKT
LMV324ID	LMV324IDR	LMV324IDRE4	LMV324IDRG4
LMV324IPWR	LMV324IPWRE4	LMV324IPWRG4	LMV324QD
LMV324QDG4	LMV324QDR	LMV324QDRG4	LMV324QPW
LMV324QPWR	LMV324QPWRE4	LMV358ID	LMV358IDDUR
LMV358IDDURG4	LMV358IDG4	LMV358IDGKR	LMV358IDGKRG4
LMV358IDR	LMV358IDRE4	LMV358IPWG4	LMV358IDRG4
LMV358IPW	LMV358IPWR	LMV358IPWRE4	LMV358IPWRG4
LMV358QD	LMV358QDDUR	LMV358QDDURG4	LMV358QDG4
LMV358QDGKR	LMV358QDGKRG4	LMV358QDR	LMV358QPWR

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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